

2SK2144 Silicon N Channel MOS FET

REJ03G1001-0200 (Previous: ADE-208-1349) Rev.2.00 Sep 07,2005

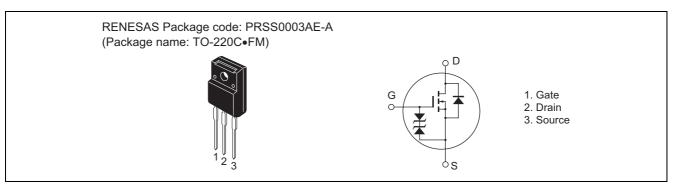
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No Secondary Breakdown
- Suitable for switching regulator, DC-DC converter

Outline





Absolute Maximum Ratings

			(1a - 25 C)
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	600	V
Gate to source voltage	V _{GSS}	±30	V
Drain current	ID	3	A
Drain peak current	I _{D(pulse)} * ¹	6	A
Body to drain diode reverse drain current	I _{DR}	3	A
Channel dissipation	Pch* ²	25	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1 %

2. Value at $Tc = 25^{\circ}C$

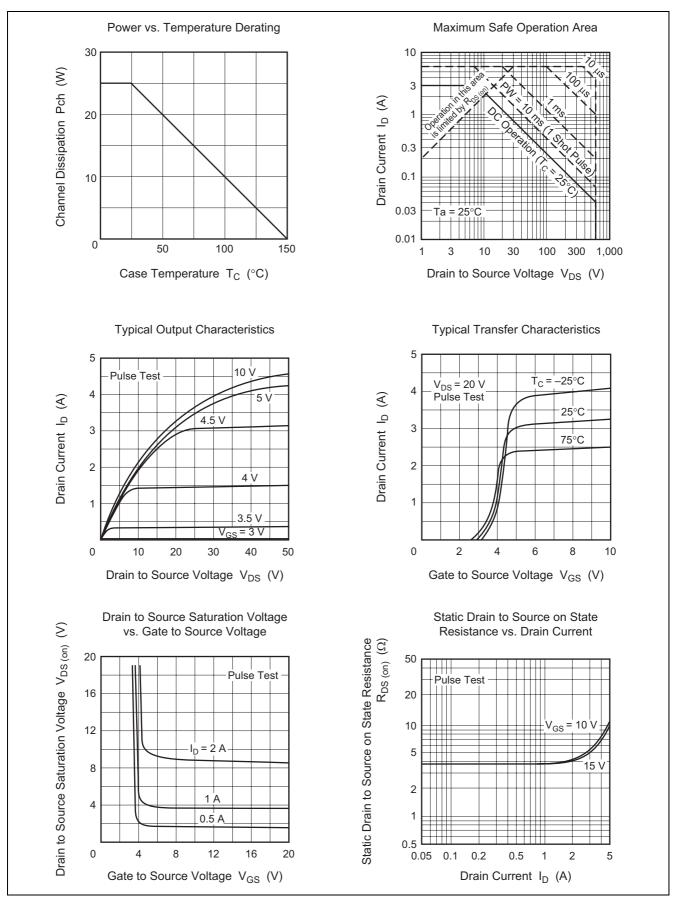
Electrical Characteristics

						$(Ta = 25^{\circ}C)$
ltem	Symbol	Min	Тур	Мах	Unit	Test conditions
Drain to source breakdown voltage	V _{(BR)DSS}	600	_		V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V _{(BR)GSS}	±30	—	—	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	—	±10	μΑ	$V_{GS} = \pm 25 V, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	—	250	μΑ	$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	2.0	—	3.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to Source on state	R _{DS(on)}		3.8	5.0	Ω	$I_D = 1 \text{ A}, V_{GS} = 10 \text{ V}^{*3}$
resistance						
Forward transfer admittance	y _{fs}	1.2	2.0	—	S	$I_D = 1 \text{ A}, V_{DS} = 10 \text{ V}^{*3}$
Input capacitance	Ciss	—	295	—	pF	$V_{DS} = 10 V, V_{GS} = 0,$
Output capacitance	Coss	_	70	—	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	12	—	pF	
Turn-on delay time	t _{d(on)}	_	8	—	ns	$I_D = 1 \text{ A}, V_{GS} = 10 \text{ V},$
Rise time	tr	_	25	—	ns	R _L = 30 Ω
Turn-off delay time	t _{d(off)}	_	65	—	ns	
Fall time	t _f	_	30	_	ns	
Body to drain diode forward voltage	V_{DF}	_	0.9	_	V	$I_F = 2 A, V_{GS} = 0$
Body to drain diode reverse	t _{rr}	_	220	_	ns	$I_F = 2 A, V_{GS} = 0,$
recovery time						$di_F / dt = 100 \text{ A} / \mu \text{s}$

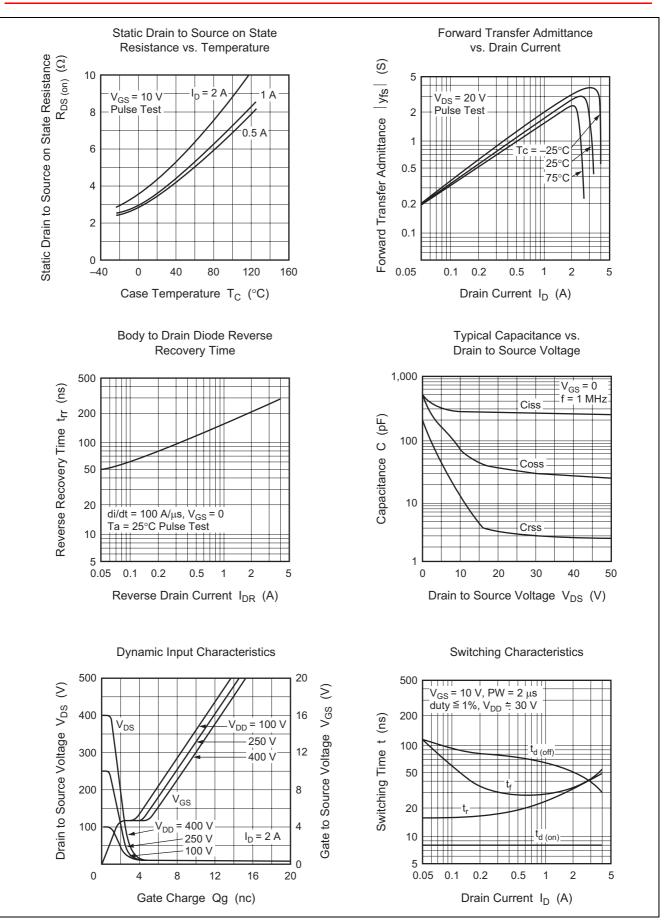
Note: 3. Pulse Test



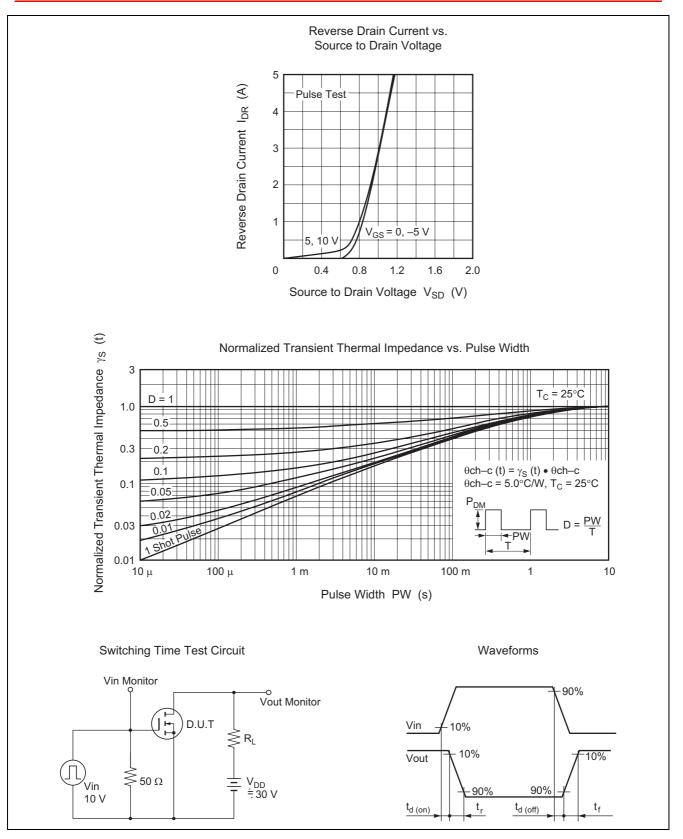
Main Characteristics





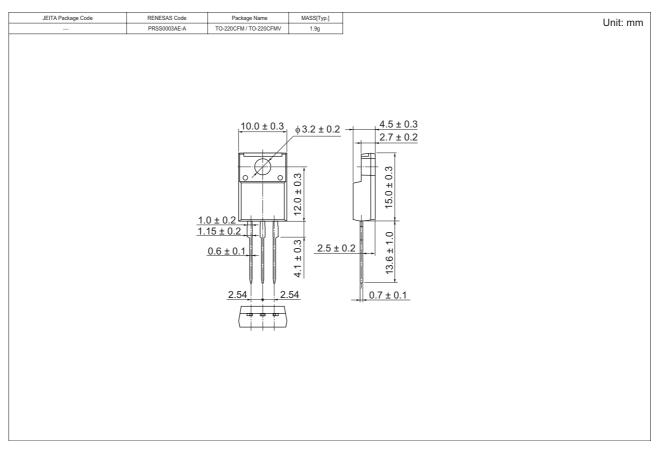








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SK2144-E	600 pcs	Box (Tube)

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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